

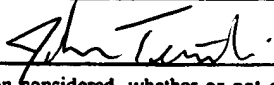
Sheet 1 of 1

Form PTO-1449 (REV. 8-83)		US Dept. of Commerce PATENT & TRADEMARK OFFICE		ATTY DOCKET NO. 119331		APPLICATION NO. New U.S. Patent Application	
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)				APPLICANTS Hiroyuki YOSHIDA et al.			
				FILING DATE April 16, 2004			

U.S. PATENT DOCUMENTS						
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS

FOREIGN PATENT DOCUMENTS						
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS
JT	1	JP A 11-118415 w/abstr. + trans.	04/30/1999	Japan		
JT	2	JP A 2000-346610 w/abstr. + trans.	12/15/2000	Japan		
JT	3	JP A 2000-346608 w/abstr. + trans.	12/15/2000	Japan		
JT	4	JP A 2001-56204 w/abstr. + trans.	02/27/2001	Japan		
JT	5	JP A 2003-254706 w/abstr. + trans.	09/10/2003	Japan		
JT	6	JP A 2001-133213 w/abstr. + trans.	05/18/2001	Japan		

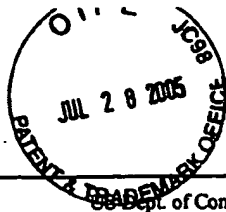
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)						

EXAMINER 	DATE CONSIDERED 11-29-05
---	-----------------------------

Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Date: April 16, 2004

[illegible]



Sheet 1 of 1

Form PTO-1449 (REV. 8-83)		U.S. Dept. of Commerce PATENT & TRADEMARK OFFICE		ATTY DOCKET NO. 119331		APPLICATION NO. 10/825,377	
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)				APPLICANTS Hiroyuki YOSHIDA et al.			
				FILING DATE April 16, 2004		GROUP 2858	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	
JT	1	US 6,411,727 B1	6/25/2002	Harkin	382	124	
JT	2	6,049,620	4/11/2000	Dickinson et al.	382	124	
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	
JT	3	WO 01/06448 A1	1/25/2001	WIPO			
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)							
JT	4	Hashido, Ryuichi et al., "A Capacitive Fingerprint Sensor Chip Using Low-Temperature Poly-Si TFTs on a Glass Substrate and a Novel and Unique Sensing Method," IEEE Journal of Solid-State Circuits, IEEE Inc., New York, U.S.					
		vol. 38, no. 2, February 2003, pages 274-280.					
JT	5	Inglis, C. et al., "A Robust, 1.8V 250µW Direct-Contact 500dpi Fingerprint Sensor", Solid-State Circuits Conference, 1998, Digest of Technical Papers. 1998 IEEE Intl. San Francisco, CA, USA 5-7 Feb. 1998, pgs. 284-285.					
EXAMINER				DATE CONSIDERED			
				11-29-05			
Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

Date: July 28, 2005